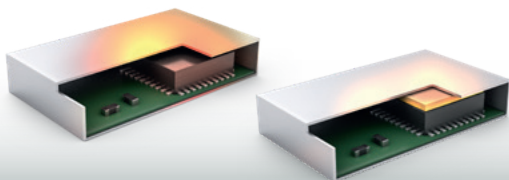




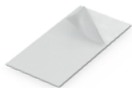
# Thermal Interface Solutions

## Vertical Thermal Interfaces



**Art. Nr. 400 001**  
**Version 1.0**

Fill a gap to provide a path for the heat energy to flow.

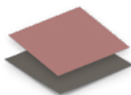


### **WE-TGF**

Silicone Gap  
Filler Pad

**K:** 1 – 10 W/mK

**T:** 0.5 – 18 mm



### **WE-TINS**

Thermally Con-  
ductive Insulator

**K:** 1.6 – 3.5 W/mK

**T:** 0.23 mm



### **WE-PCM**

Phase Changing  
Material

**K:** 1.6 – 5 W/mK

**T:** 0.2 mm



### **WE-TTT**

Thermal Transfer  
Tape

**K:** 1 W/mK

**T:** 0.2 mm